

HD74LV273A

Octal D-type Flip-Flops with Clear

HITACHI

ADE-205-273 (Z)

1st Edition

April 1999

Description

The HD74LV273A has eight edge trigger D-type flip-flops with clear in a 20-pin package. Data on the D input having the specified setup and hold times is transferred to the Q output on the low to high transition of the clock input. The clear input when low, sets all outputs to a low state. Low-voltage and high-speed operation is suitable for battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

Features

- $V_{CC} = 2.0\text{ V}$ to 5.5 V operation
- All inputs $V_{IH}(\text{Max.}) = 5.5\text{ V}$ ($@V_{CC} = 0\text{ V}$ to 5.5 V)
- All outputs $V_O(\text{Max.}) = 5.5\text{ V}$ ($@V_{CC} = 0\text{ V}$)
- Typical V_{OL} ground bounce $< 0.8\text{ V}$ ($@V_{CC} = 3.3\text{ V}$, $T_a = 25^\circ\text{C}$)
- Typical V_{OH} undershoot $> 2.3\text{ V}$ ($@V_{CC} = 3.3\text{ V}$, $T_a = 25^\circ\text{C}$)
- Output current $\pm 6\text{ mA}$ ($@V_{CC} = 3.0\text{ V}$ to 3.6 V), $\pm 16\text{ mA}$ ($@V_{CC} = 4.5\text{ V}$ to 5.5 V)

Function Table

| Inputs | | | |
|--------|-----|---|----------|
| CLR | CLK | D | Output Q |
| L | X | X | L |
| H | ↑ | H | H |
| H | ↑ | L | L |
| H | ↓ | X | Q_0 |

Note: H: High level

L: Low level

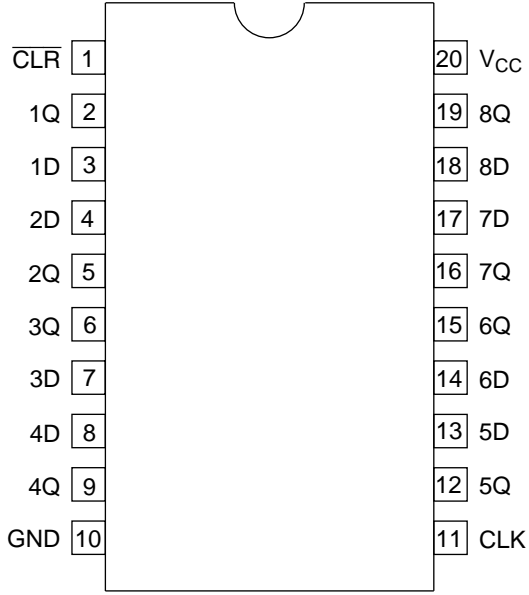
X: Immaterial

↑: Low to high transition

↓: High to low transition

Q_0 : Output level before the indicated steady state input conditions were established.

Pin Arrangement



(Top view)

Absolute Maximum Ratings

| Item | Symbol | Ratings | Unit | Conditions |
|--|-----------------------|---------------------------------------|------------------|----------------------------------|
| Supply voltage range | V_{CC} | -0.5 to 7.0 | V | |
| Input voltage range* ¹ | V_I | -0.5 to 7.0 | V | |
| Output voltage range* ^{1,2} | V_O | -0.5 to $V_{CC} + 0.5$ -0.5 to 7.0 | V | Output: H or L V_{CC} : OFF |
| Input clamp current | I_{IK} | -20 | mA | $V_I < 0$ |
| Output clamp current | I_{OK} | ± 50 | mA | $V_O < 0$ or $V_O > V_{CC}$ |
| Continuous output current | I_O | ± 25 | mA | $V_O = 0$ to V_{CC} |
| Continuous current through V_{CC} or GND | I_{CC} or I_{GND} | ± 50 | mA | |
| Maximum power dissipation at $T_a = 25^\circ\text{C}$ (in still air)* ³ | P_T | 835 | mW | SOP |
| | | 757 | | TSSOP |
| Storage temperature | T_{stg} | -65 to 150 | $^\circ\text{C}$ | |

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

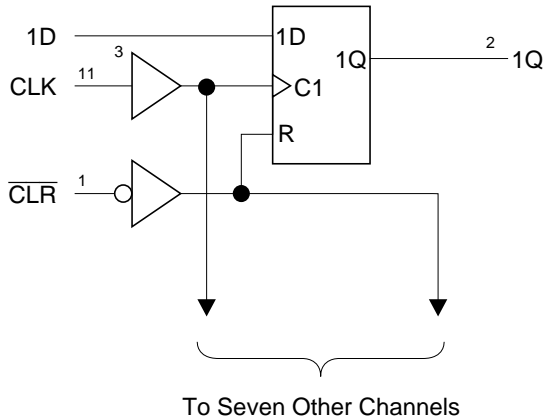
1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 5.5 V maximum.
3. The maximum package power dissipation was calculated using a junction temperature of 150°C .

Recommended Operating Conditions

| Item | Symbol | Min | Max | Unit | Conditions |
|------------------------------------|-----------------------|-----|----------|-------------|----------------------------------|
| Supply voltage range | V_{CC} | 2.0 | 5.5 | V | |
| Input voltage range | V_I | 0 | 5.5 | V | |
| Output voltage range | V_O | 0 | V_{CC} | V | H or L |
| Output current | I_{OH} | — | -50 | μA | $V_{CC} = 2.0 V$ |
| | | — | -2 | mA | $V_{CC} = 2.3 \text{ to } 2.7 V$ |
| | | — | -6 | | $V_{CC} = 3.0 \text{ to } 3.6 V$ |
| | | — | -12 | | $V_{CC} = 4.5 \text{ to } 5.5 V$ |
| | I_{OL} | — | 50 | μA | $V_{CC} = 2.0 V$ |
| | | — | 2 | mA | $V_{CC} = 2.3 \text{ to } 2.7 V$ |
| | | — | 6 | | $V_{CC} = 3.0 \text{ to } 3.6 V$ |
| | | — | 12 | | $V_{CC} = 4.5 \text{ to } 5.5 V$ |
| Input transition rise or fall rate | $\Delta t / \Delta v$ | 0 | 200 | ns/V | $V_{CC} = 2.3 \text{ to } 2.7 V$ |
| | | 0 | 100 | | $V_{CC} = 3.0 \text{ to } 3.6 V$ |
| | | 0 | 20 | | $V_{CC} = 4.5 \text{ to } 5.5 V$ |
| Operating free-air temperature | T_a | -40 | 85 | $^{\circ}C$ | |

Note: Unused or floating inputs must be held high or low.

Logic Diagram



DC Electrical Characteristics

- $T_a = -40$ to 85°C

| Item | Symbol | V_{CC} (V)* | Min | Typ | Max | Unit | Test Conditions |
|--------------------------|-----------|---------------|---------------------|-----|---------------------|---------------|---|
| Input voltage | V_{IH} | 2.0 | 1.5 | — | — | V | |
| | | 2.3 to 2.7 | $V_{CC} \times 0.7$ | — | — | | |
| | | 3.0 to 3.6 | $V_{CC} \times 0.7$ | — | — | | |
| | | 4.5 to 5.5 | $V_{CC} \times 0.7$ | — | — | | |
| | V_{IL} | 2.0 | — | — | 0.5 | | |
| | | 2.3 to 2.7 | — | — | $V_{CC} \times 0.3$ | | |
| | | 3.0 to 3.6 | — | — | $V_{CC} \times 0.3$ | | |
| | | 4.5 to 5.5 | — | — | $V_{CC} \times 0.3$ | | |
| Output voltage | V_{OH} | Min to Max | $V_{CC} - 0.1$ | — | — | V | $I_{OH} = -50 \mu\text{A}$ |
| | | 2.3 | 2.0 | — | — | | $I_{OH} = -2 \text{ mA}$ |
| | | 3.0 | 2.48 | — | — | | $I_{OH} = -6 \text{ mA}$ |
| | | 4.5 | 3.8 | — | — | | $I_{OH} = -12 \text{ mA}$ |
| | V_{OL} | Min to Max | — | — | 0.1 | | $I_{OL} = 50 \mu\text{A}$ |
| | | 2.3 | — | — | 0.4 | | $I_{OL} = 2 \text{ mA}$ |
| | | 3.0 | — | — | 0.44 | | $I_{OL} = 6 \text{ mA}$ |
| | | 4.5 | — | — | 0.55 | | $I_{OL} = 12 \text{ mA}$ |
| Input current | I_{IN} | 0 to 5.5 | — | — | ± 1 | μA | $V_I = 5.5 \text{ V}$ or GND |
| Quiescent supply current | I_{CC} | 5.5 | — | — | 20 | μA | $V_I = V_{CC}$ or GND, $I_O = 0$ |
| Output leakage current | I_{OFF} | 0 | — | — | 5 | μA | V_I or $V_O = 0 \text{ V}$ to 5.5 V |
| Input capacitance | C_{IN} | 3.3 | — | 2 | — | pF | $V_I = V_{CC}$ or GND |

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

- $V_{CC} = 2.5 \pm 0.2 \text{ V}$

Ta = 25°C Ta = -40 to 85°C

| Item | Symbol | Min | Typ | Max | Min | Max | Unit | Test Conditions | FROM (Input) | TO (Output) |
|-------------------------|-------------------------------------|-----|------|------|------|------|------------------------|-------------------------|----------------------------------|-------------|
| Maximum clock frequency | fmax | 55 | 95 | — | 45 | — | MHz | C _L = 15 pF | | |
| | | 45 | 75 | — | 40 | — | | | | |
| Propagation delay time | t _{PHL} | — | 10.3 | 19.0 | 1.0 | 21.0 | ns | C _L = 15 pF | $\overline{\text{CLR}}$ | Q |
| | t _{PLH} / t _{PHL} | — | 10.4 | 18.3 | 1.0 | 20.5 | | | CLK | Q |
| | t _{PHL} | — | 13.1 | 22.8 | 1.0 | 25.5 | C _L = 50 pF | $\overline{\text{CLR}}$ | Q | |
| | t _{PLH} / t _{PHL} | — | 12.9 | 22.1 | 1.0 | 25.0 | | CLK | Q | |
| Setup time | t _{SU} | 8.5 | — | — | 10.5 | — | ns | | Data | |
| | | 4.0 | — | — | 4.0 | — | | | $\overline{\text{CLR}}$ inactive | |
| Hold time | t _H | 0.5 | — | — | 1.0 | — | ns | | | |
| Pulse width | t _W | 6.5 | — | — | 7.0 | — | ns | | $\overline{\text{CLR}}$ L | |
| | | 7.0 | — | — | 8.5 | — | | | CLK H or L | |

Switching Characteristics (cont)

- $V_{CC} = 3.3 \pm 0.3 \text{ V}$

| Item | Symbol | Ta = 25°C | | | Ta = -40 to 85°C | | Unit | Test Conditions | FROM (Input) | TO (Output) |
|-------------------------|-------------------------------------|-----------|-----|------|------------------|------|------------------------|-------------------------|----------------------------------|----------------|
| | | Min | Typ | Max | Min | Max | | | | |
| Maximum clock frequency | fmax | 75 | 140 | — | 65 | — | MHz | C _L = 15 pF | | |
| | | 50 | 110 | — | 45 | — | | | | |
| Propagation delay time | t _{PHL} | — | 6.9 | 13.6 | 1.0 | 16.0 | ns | C _L = 15 pF | $\overline{\text{CLR}}$ | Q |
| | t _{PLH} / t _{PHL} | — | 7.1 | 13.6 | 1.0 | 16.0 | | | CLK | Q |
| | t _{PHL} | — | 8.7 | 17.1 | 1.0 | 19.5 | C _L = 50 pF | $\overline{\text{CLR}}$ | Q | |
| | t _{PLH} / t _{PHL} | — | 9.1 | 17.1 | 1.0 | 19.5 | | CLK | Q | |
| Setup time | t _{SU} | 5.5 | — | — | 6.5 | — | ns | | Data | |
| | | 2.5 | — | — | 2.5 | — | | | $\overline{\text{CLR}}$ inactive | |
| Hold time | t _H | 1.0 | — | — | 1.0 | — | ns | | | |
| Pulse width | t _W | 5.0 | — | — | 6.0 | — | ns | | $\overline{\text{CLR}}$ L | |
| | | 5.5 | — | — | 6.5 | — | | | CLK H or L | |

Switching Characteristics (cont)

- $V_{CC} = 5.0 \pm 0.5 \text{ V}$

| Item | Symbol | Ta = 25°C | | | Ta = -40 to 85°C | | Unit | Test Conditions | FROM (Input) | TO (Output) |
|-------------------------|-------------------------------------|-----------|-----|------|------------------|------|------------------------|-------------------------|----------------------------------|----------------|
| | | Min | Typ | Max | Min | Max | | | | |
| Maximum clock frequency | fmax | 120 | 205 | — | 100 | — | MHz | C _L = 15 pF | | |
| | | 80 | 160 | — | 70 | — | | | | |
| Propagation delay time | t _{PHL} | — | 4.7 | 8.5 | 1.0 | 10.0 | ns | C _L = 15 pF | $\overline{\text{CLR}}$ | Q |
| | t _{PLH} / t _{PHL} | — | 4.8 | 9.0 | 1.0 | 10.5 | | | CLK | Q |
| | t _{PHL} | — | 6.0 | 10.5 | 1.0 | 12.0 | C _L = 50 pF | $\overline{\text{CLR}}$ | Q | |
| | t _{PLH} / t _{PHL} | — | 6.2 | 11.0 | 1.0 | 12.5 | | CLK | Q | |
| Setup time | t _{SU} | 4.5 | — | — | 4.5 | — | ns | | Data | |
| | | 2.0 | — | — | 2.0 | — | | | $\overline{\text{CLR}}$ inactive | |
| Hold time | t _H | 1.0 | — | — | 1.0 | — | ns | | | |
| Pulse width | t _W | 5.0 | — | — | 5.0 | — | ns | | $\overline{\text{CLR}}$ L | |
| | | 5.0 | — | — | 5.0 | — | | | CLK H or L | |

Output-skew Characteristics

| Item | Symbol | $V_{CC} = (V)$ | $T_a = 25^\circ\text{C}$ | | $T_a = -40 \text{ to } 85^\circ\text{C}$ | | Unit |
|-------------|-------------|----------------|--------------------------|-----|--|-----|------|
| | | | Min | Max | Min | Max | |
| Output skew | $t_{sk(O)}$ | 2.3 to 2.7 | — | 2.0 | — | 2.0 | ns |
| | | 3.0 to 3.6 | — | 1.5 | — | 1.5 | |
| | | 4.5 to 5.5 | — | 1.0 | — | 1.0 | |

Note: Skew between any outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

Operating Characteristics

- $C_L = 50 \text{ pF}$

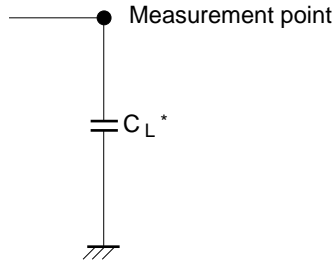
| Item | Symbol | $V_{CC} = (V)$ | $T_a = 25^\circ\text{C}$ | | | Unit | Test Conditions |
|-------------------------------|----------|----------------|--------------------------|------|-----|------|----------------------|
| | | | Min | Typ | Max | | |
| Power dissipation capacitance | C_{PD} | 3.3 | — | 15.9 | — | pF | $f = 10 \text{ MHz}$ |
| | | 5.0 | — | 17.1 | — | | |

Noise Characteristics

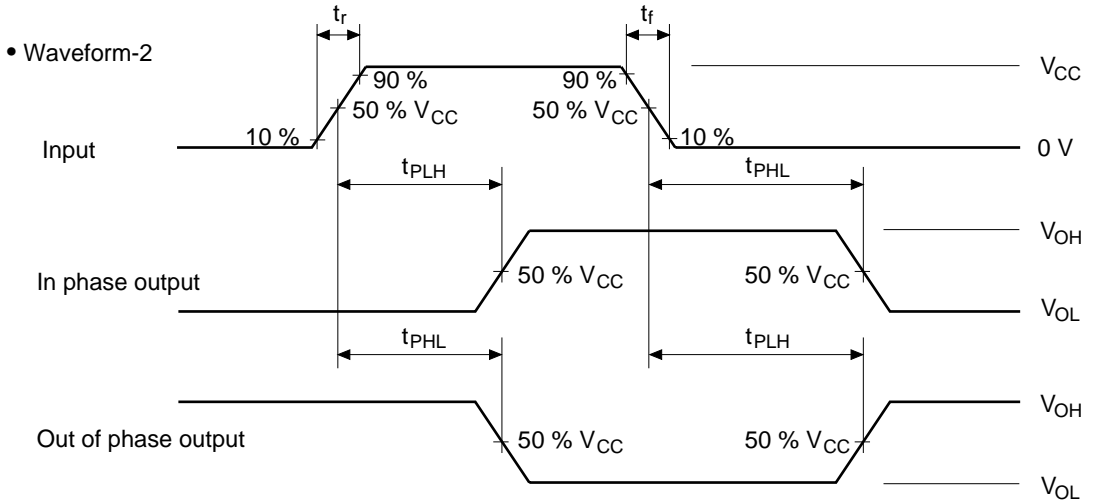
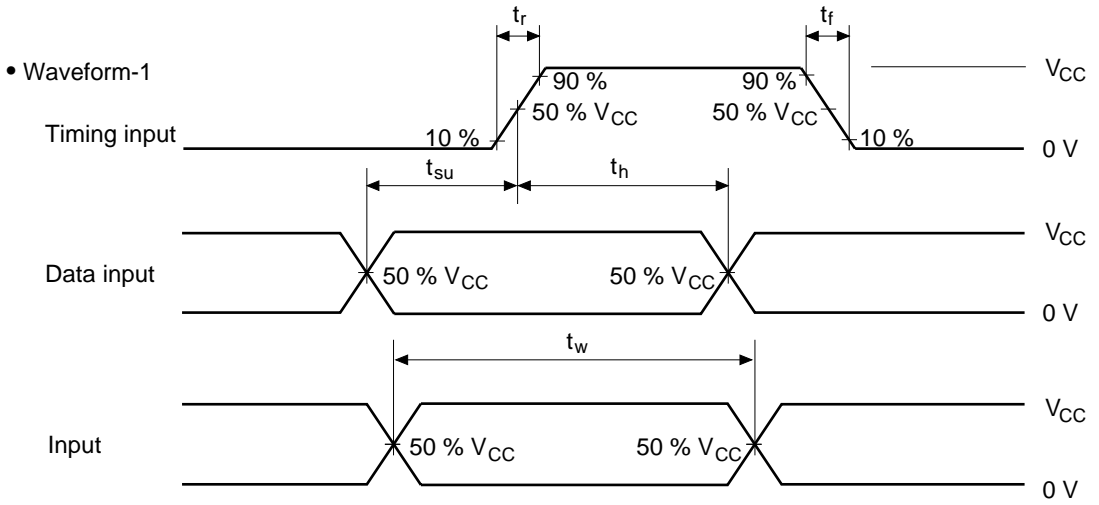
- $C_L = 50 \text{ pF}$

| Item | Symbol | $V_{CC} = (V)$ | $T_a = 25^\circ\text{C}$ | | | Unit | Test Conditions |
|--|-------------|----------------|--------------------------|------|------|------|-----------------|
| | | | Min | Typ | Max | | |
| Quiet output, maximum dynamic V_{OL} | $V_{OL(P)}$ | 3.3 | — | 0.4 | 0.8 | V | |
| Quiet output, minimum dynamic V_{OL} | $V_{OL(V)}$ | 3.3 | — | -0.4 | -0.8 | | |
| Quiet output, minimum dynamic V_{OH} | $V_{OH(V)}$ | 3.3 | — | 2.9 | — | | |
| High-level dynamic input voltage | $V_{IH(D)}$ | 3.3 | 2.31 | — | — | V | |
| Low-level dynamic input voltage | $V_{IL(D)}$ | 3.3 | — | — | 0.99 | | |

Test Circuit

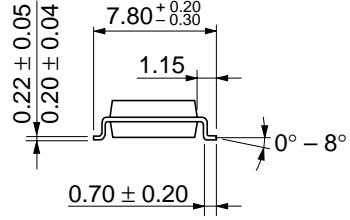
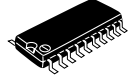
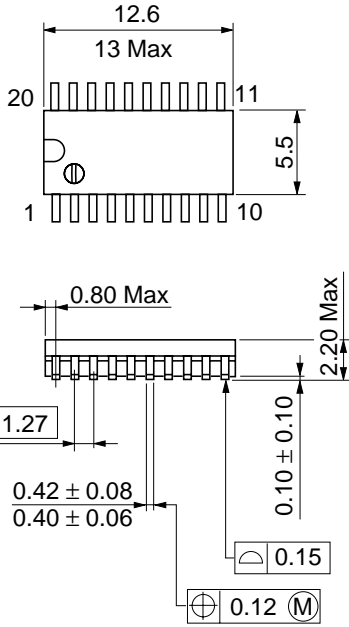


Note: C_L includes the probe and jig capacitance.



- Notes: 1. Input waveform: $PRR \leq 1 \text{ MHz}$, $Z_o = 50 \Omega$, $t_r \leq 3 \text{ ns}$, $t_f \leq 3 \text{ ns}$
 2. The output is measured one at a time with one transition per measurement.

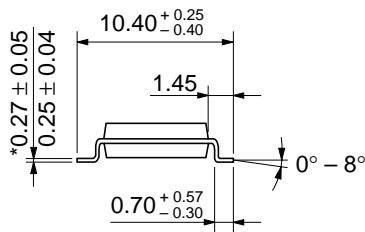
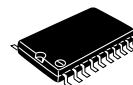
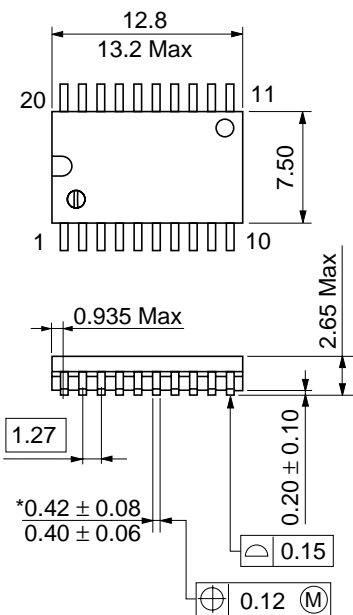
Package Dimensions



Dimension including the plating thickness
Base material dimension

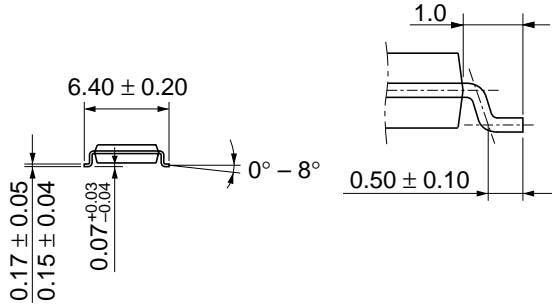
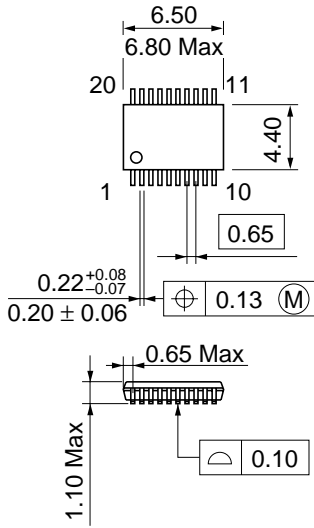
| | |
|--------------------------|----------|
| Hitachi Code | FP-20DA |
| JEDEC | — |
| EIAJ | Conforms |
| Weight (reference value) | 0.31 g |

Unit: mm



*Dimension including the plating thickness
 Base material dimension

| | |
|--------------------------|----------|
| Hitachi Code | FP-20DB |
| JEDEC | Conforms |
| EIAJ | — |
| Weight (reference value) | 0.52 g |



Dimension including the plating thickness
Base material dimension

| | |
|--------------------------|----------|
| Hitachi Code | TTP-20DA |
| JEDEC | — |
| EIAJ | — |
| Weight (reference value) | 0.07 g |

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